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# **FDP027N08B** N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 223 A, 2.7 mΩ

## **Features**

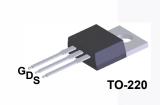
- $R_{DS(on)}$  = 2.21 m $\Omega$  (Typ.) @  $V_{GS}$  = 10 V, I<sub>D</sub> = 100 A
- Low FOM R<sub>DS(on)</sub> \* Q<sub>G</sub>
- Low Reverse-Recovery Charge, Q<sub>rr</sub> = 112 nC
- Soft Reverse-Recovery Body Diode
- Enables High Efficiency in Synchronous Rectification
- · Fast Switching Speed
- · 100% UIL Tested
- · RoHS Compliant

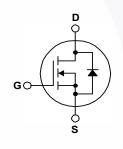
# Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

# Applications

- · Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- · Motor Drives and Uninterruptible Power Supplies





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parameter		FDP027N08B_F102	Unit	
V <sub>DSS</sub>	Drain to Source Voltage		80	V	
V <sub>GSS</sub>	Gate to Source Voltage		±20	V	
I <sub>D</sub> Drair		- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Silicon Limited)	223*	223* 158* A	
	Drain Current	- Continuous (T <sub>C</sub> = 100 <sup>o</sup> C, Silicon Limited)	158*		
		- Continuous (T <sub>C</sub> = 25 <sup>o</sup> C, Package Limited)	120		
I <sub>DM</sub>	Drain Current	- Pulsed (Note 1)	892	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		917	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.0	V/ns	
P <sub>D</sub> Po	Power Dissinction	(T <sub>C</sub> = 25°C)	246	W	
	Power Dissipation	- Derate Above 25°C	1.64	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds		300	°C	

\*Calculated continuous current based on maximum allowable junction temperature. Package limitation current is 120 A.

# **Thermal Characteristics**

Symbol	Parameter FDP027N08B_F		Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max. 0.61			
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	°C/W	

November 2013

		Package	•		Тар	e Width	Qua	ntity	
		TO-220				N/A	50 units		
Electrica	I Chara	acteristics $T_c$ =	25°C unless	otherwise noted.					
Symbol		Parameter		Test Conditions		Min.	Тур.	Max.	Unit
Off Charac	teristics	1							
BV <sub>DSS</sub>	1	, Source Breakdown V	oltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0 V		80	_	_	V
ΔBV <sub>DSS</sub>		wn Voltage Temperat	0	$I_D = 250 \ \mu\text{A}, \ \text{Referenced to } 25^{\circ}\text{C}$		00			
$/\Delta T_J$	Coefficie	<b>U</b> 1				-	0.05	-	V/°C
				V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V		-	-	1	
DSS	Zero Gat	te Voltage Drain Curro	ent	$V_{\rm DS} = 64 \text{ V}, T_{\rm C} = 150^{\circ}\text{C}$		-	-	500	μA
I <sub>GSS</sub>	Gate to E	Body Leakage Currer	nt	$V_{GS} = \pm 20 \text{ V}, \text{ V}_{DS} = 0$		-	-	±100	nA
On Charac	toriotico							1	
			_	V = V   = 250 ···	^	25		4.5	V
V <sub>GS(th)</sub>		eshold Voltage	iotonoo	$V_{GS} = V_{DS}, I_{D} = 250 \mu$		2.5	-	4.5 2.7	
R <sub>DS(on)</sub>			sistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$ $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 100 \text{ A}$		-	2.21 227		mΩ S
9 <sub>FS</sub>		Transconductance		$v_{\rm DS} = 10 v, i_{\rm D} = 100 v$		-	221	-	3
Dynamic C	haracte	ristics							-
C <sub>iss</sub>	Input Ca	t Capacitance		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V,		-	10170	13530	pF
C <sub>oss</sub>	Output C	apacitance		f = 1  MHz		-	1670	2220	pF
C <sub>rss</sub>	Reverse	Transfer Capacitance	e			-	35	-	pF
C <sub>oss</sub> (er)	Engry Related Output Capacitance		ance	$V_{DS}$ = 40 V, $V_{GS}$ = 0 V		-	3025	-	pF
Q <sub>g(tot)</sub>	Total Gat	e Charge at 10V				-	137	178	nC
Q <sub>gs</sub>	Gate to S	Source Gate Charge		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = 100A f = 1 MHz		-	56	-	nC
Q <sub>gs2</sub>	Gate Cha	arge Threshold to Pla	iteau			-	25	-	nC
Q <sub>gd</sub>	Gate to E	Drain "Miller" Charge				-	28	-	nC
ESR	Equivale	nt Series Resistance	(G-S)			-	2.4	-	Ω
Switching	Charact	eristics							
t <sub>d(on)</sub>		Delay Time					47	104	ns
t <sub>r</sub>	Turn-On	Rise Time		$V_{DD}$ = 40 V, I <sub>D</sub> = 100 A, $V_{GS}$ = 10 V, R <sub>G</sub> = 4.7 Ω (Note 4)			66	142	ns
t <sub>d(off)</sub>	Turn-Off	Delay Time				-	87	184	ns
t <sub>f</sub>	Turn-Off	Fall Time				7-	41	92	ns
Drain Sour		e Characteristic	e						
				e Forward Current		-	-	223*	А
I <sub>S</sub> I	Maximum Continuous Drain to Source Dio							892	
I <sub>SM</sub>	Maximum Pulsed Drain to Source Diode Fo					-	-		A V
V <sub>SD</sub>			u voltage	$V_{GS} = 0 V, I_{SD} = 100 A$		-	- 80	1.3	
t <sub>rr</sub>		Recovery Time		$V_{GS} = 0 V, V_{DD} = 40 V$	/, I <sub>SD</sub> = 100 A,	-	80	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge $dI_F/dt = 100 A/\mu s$			-	112	-	nC		

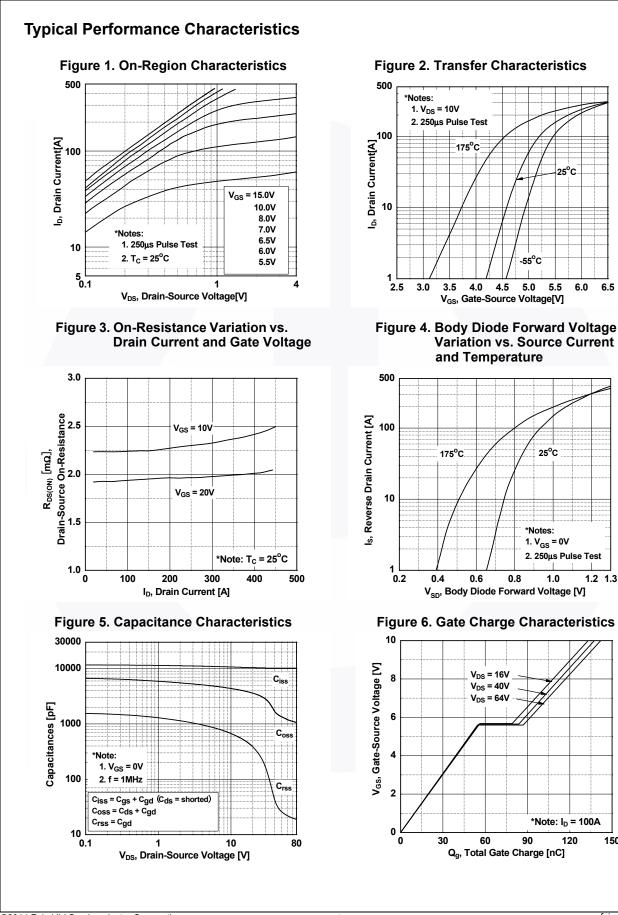
 $\begin{array}{l} \text{2. L}=3\text{ mH},\ \text{I}_{AS}=24.72\text{ A},\ \text{R}_{G}=25\ \Omega,\ \text{starting }\ \text{T}_{J}=25^{\circ}\text{C}.\\ \text{3. I}_{SD}\leq100\text{ A},\ \text{di/dt}\leq200\text{ A/}\mu\text{s},\ \text{V}_{DD}\leq\text{BV}_{DSS},\ \text{starting }\ \text{T}_{J}=25^{\circ}\text{C}. \end{array}$ 

Essentially independent of operating temperature typical characteristics.

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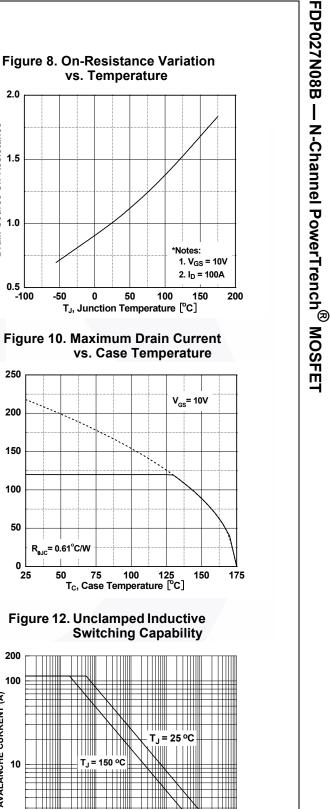
1.2 1.3

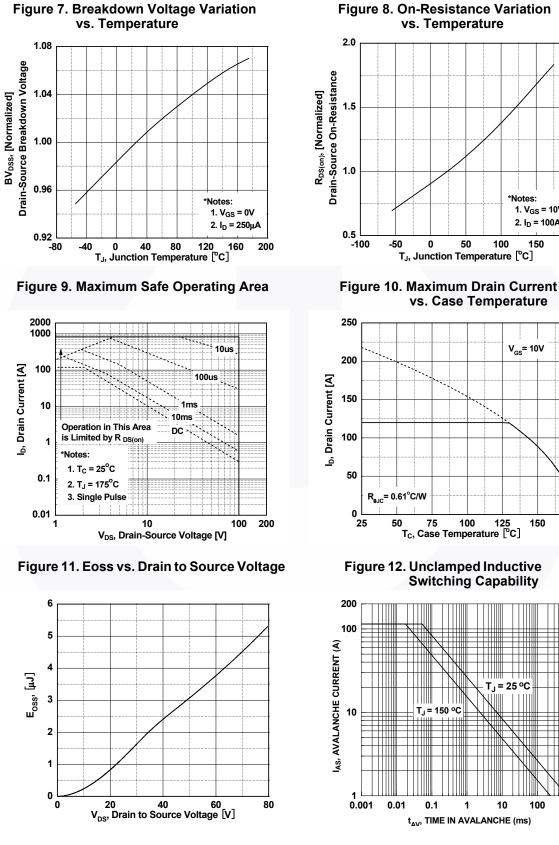


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150





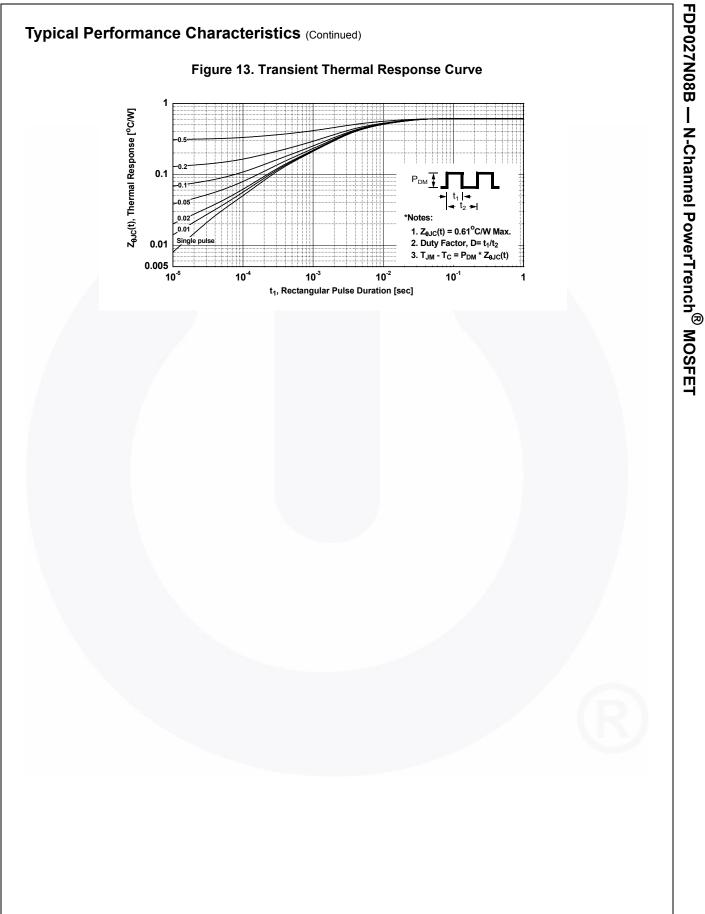
### Typical Performance Characteristics (Continued)

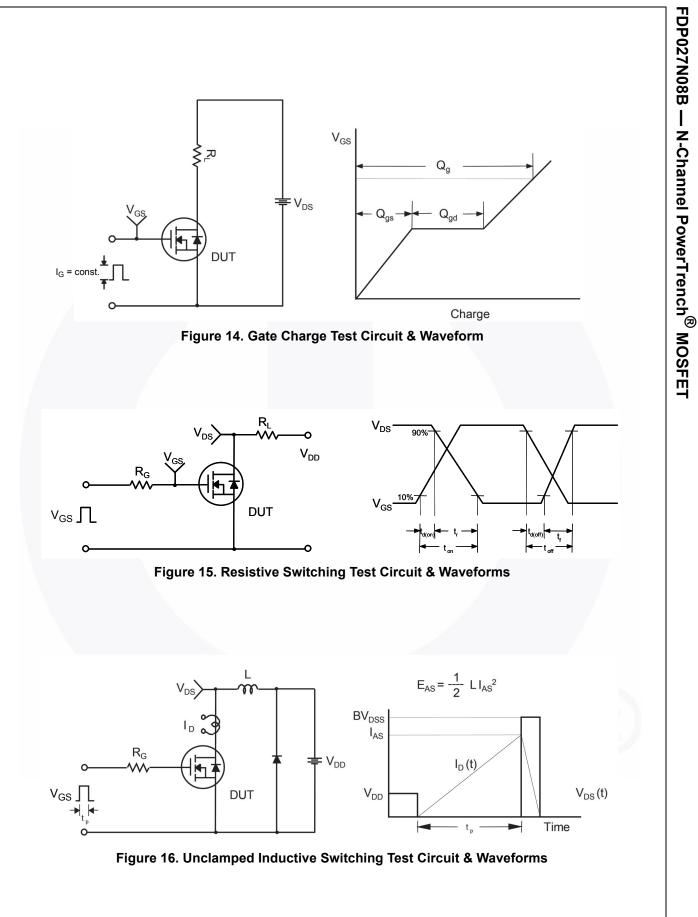
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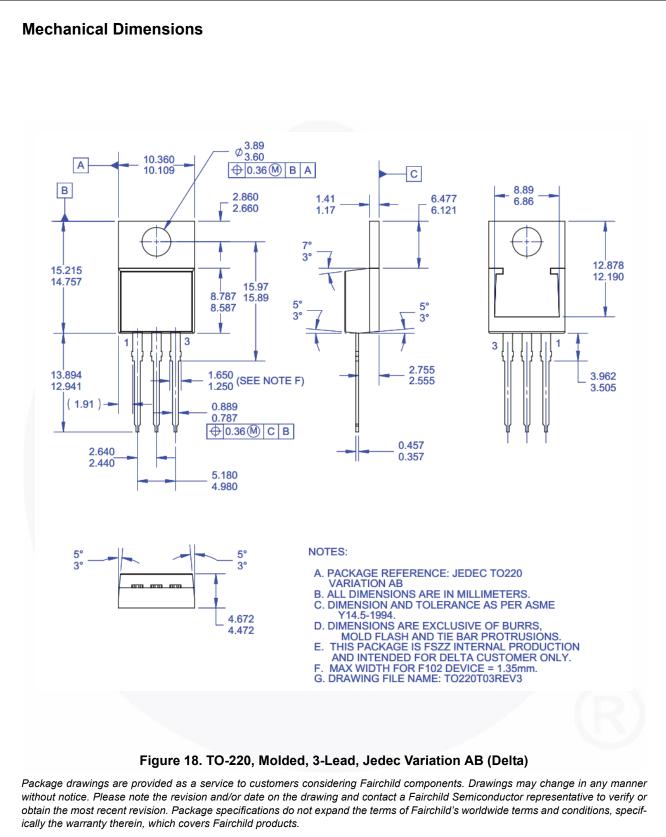
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DUT +  $v_{DS}$ a ۱<sub>SD</sub> م L Driver R<sub>G</sub>, Same Type as DUT L F ∨<sub>DD</sub>  $\prod V_{GS}$ • dv/dt controlled by R<sub>G</sub> • I<sub>SD</sub> controlled by pulse period Î Gate Pulse Width V<sub>GS</sub> D = Gate Pulse Period 10V (Driver) I<sub>FM</sub>, Body Diode Forward Current I <sub>SD</sub> di/dt (DUT)  $I_{RM}$ Body Diode Reverse Current  $V_{DS}$ (DUT) Body Diode Recovery dv/dt  $V_{SD}$ V<sub>PD</sub> Body Diode Forward Voltage Drop Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms

7



http://www.fairchildsemi.com/package/packageDetails.html?id=PN\_TT220-0I3

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